

Prototyping boards

Veroboard pattern with colander ground plane

Similar in use to the standard Veroboard pattern but offering the advantages of full OV colander ground plane to provide maximum screening on the component side of the board.

Features

- DIN 41494 cardframe compatible and DIN 41612 connector pattern up to 96/96 ways
- Ideal for hard wiring of discrete components
- Colander ground plane for maximum screening
- Microbus backplane compatible

Veroboard pattern, with colander gound plane

Ordering information

Board dims.	Tracks	Holes/tracks	Base material	Order code
100 x 160	34	54	Epoxy glass	03-2990

Note: Hole grid 2,54 x 2,54mm, hole dia. 1,02mm and 3,81mm gap on double height boards

Square pad board

A range of boards offering total flexibility and maximum density of wirewrapped circuitry. Any size of wirewrapping DIP socket or terminal pin can be accepted in either X or Y planes. Vcc and 0V rails may be daisy chained from post to post around the board eliminating the need to stake pins in power rails as on other types of board.

Features

- Maximum packing density
- Total flexibility using hard wire or wirewrapping techniques
- DIN 41494 cardframe compatible and DIN 41612 connector pattern up to 96/96 ways
- Grid references to both sides of board to aid component layout and to assist wiring
- Microbus backplane compatible

Note: Component grids compatible with connectors. Board 03-0111L has a full board pattern aligned with the lower connector giving a 1,27mm offset between the top and bottom connector patterns.

Square pad boar	rd		Ord	dering information
Board dimensions	No.	of Pads	Base material	Order
	width	length		code
100 x160	34	54	Epoxy glass	03-0026
100 x 220	34	77	Epoxy glass	03-27555
233,4 x 160	85	52	Epoxy glass	03-0111
233,4 x 160	86	52	Epoxy glass	03-27556*
233,4 x 220	86	75	Epoxy glass	03-27557*

Note: Hole grid 2,54 x 2,54mm Hole dia. 1,02mm *3,81mm gap on these boards

Square pad board with colander ground plane

A single height Eurocard similar to the standard square pad board but offering the additional advantage of OV colander ground plane.

Features

- Maximum packing density
- Total flexibility using hard wire or wire wrapping techniques
- Colander ground plane for maximum screening
- DIN 41494 cardframe compatible and DIN 41612 connector pattern up to 96/96 ways
- Grid references to both sides of board to aid component layout and to assist wiring
- Microbus backplane compatible

Square pad board with colander ground plane

Ordering information

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Board	No. of Pads		Base	Order
dimensions	width	length	material	code
100 x 160	34	54	Epoxy glass	03-2989



